光电子集成电路(PIC)测试技术 与EXFO晶圆级测试方案介绍

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2023年2月28日





光电子集成电路 (PIC) 的市场与应用





CONSUMER PRODUCTS

MEDICAL & BIO







AUTONOMOUS CARS

PHOTONIC PROCESSING & COMPUTING



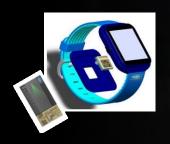
GOVERNMENT & MILITARY

DATACOM

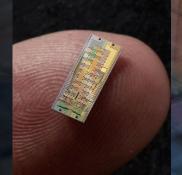


INDUSTRY 4.0

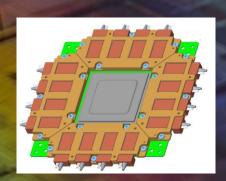
TELECOM (FTTx)

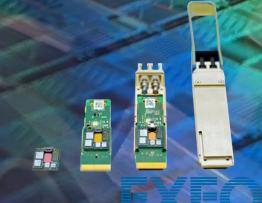


Wearable Spectrometer - Apple/Rockley



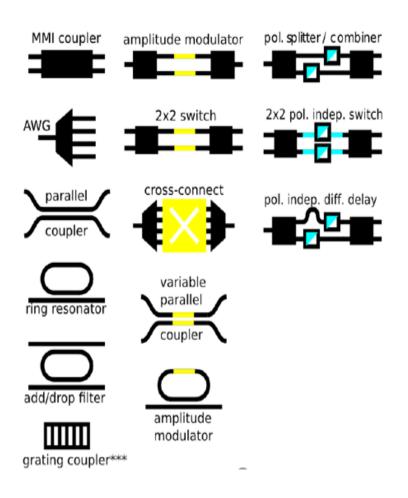
Quantum photonic chip (die) - Xanadu X8



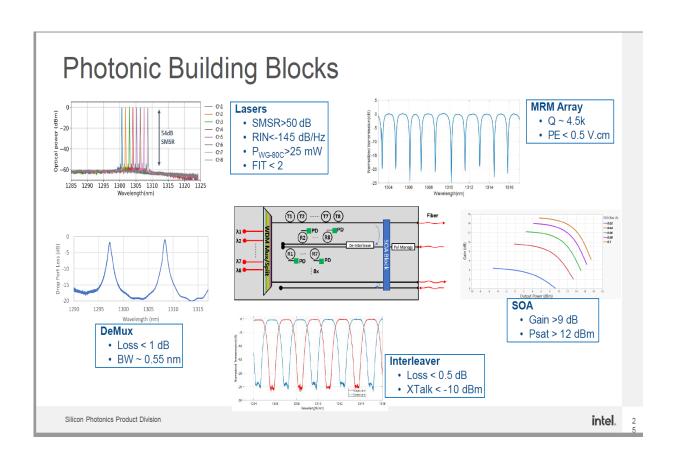


硅光不同类型器件与系统

Typical SiPh component



CPO building block (from intel)



测试目标与挑战

Accurate / repeatable

Traceable results, no assumption or extrapolation.

Dynamic range

See the full spectral contrast in a single measurement.

Speedy

Minimize total testing time.

Integrated

Simple design easily connects to a system.

Flexible / scalable

Ability to add functions and features over time.

Automated

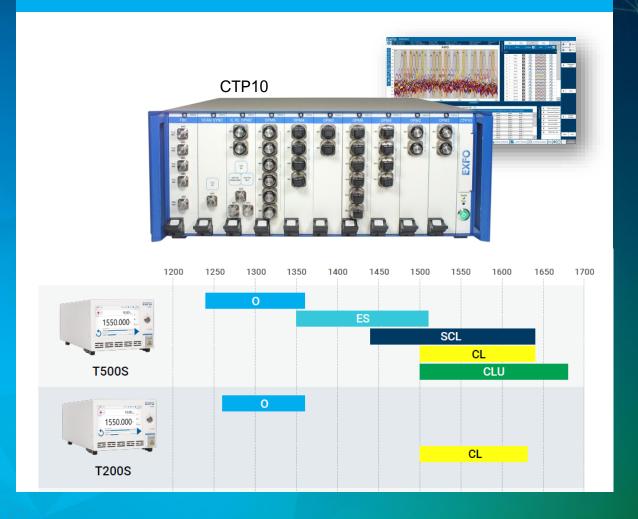
Full test control, quicker configuration.

SPECTRAL TESTING RING RESONATOR

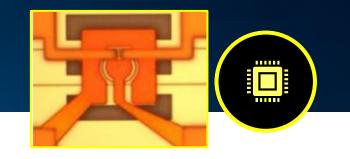
- 1240 1680 nm
- ±5 pm acc, < 1 pm repeat
- 1 pm Resolution
- 70dB in a single scan
- 1dB/µs tracking

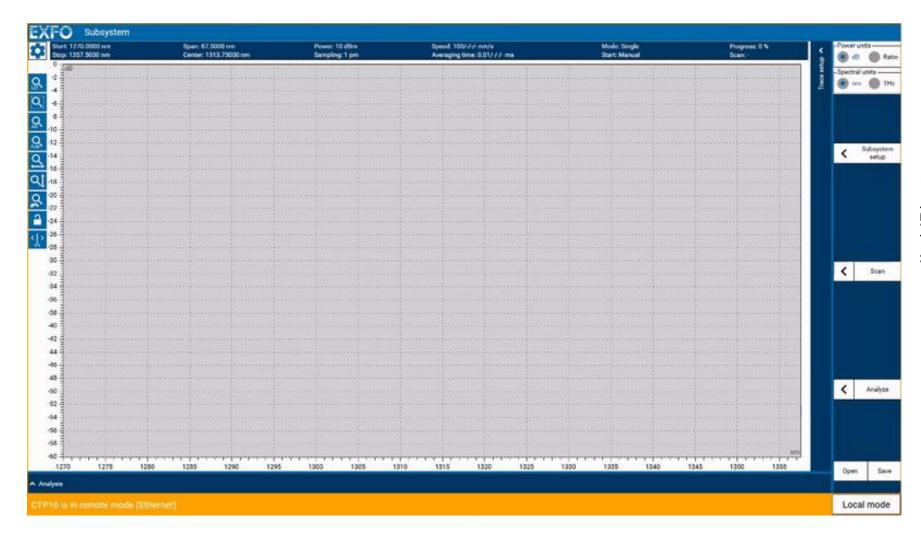


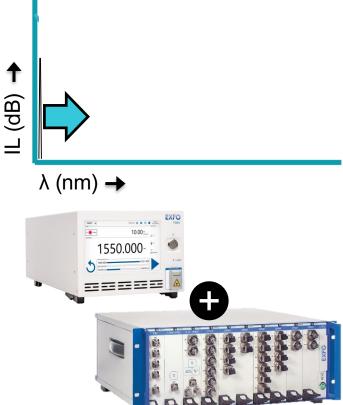
COMPONENT TEST PLATFORM & TUNABLE LASERS



测试举例: 先进器件的光谱测试



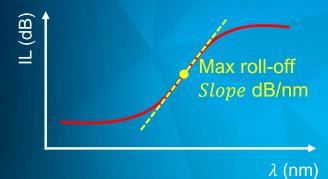




EXFO component testing solution

陡峭沿跟踪

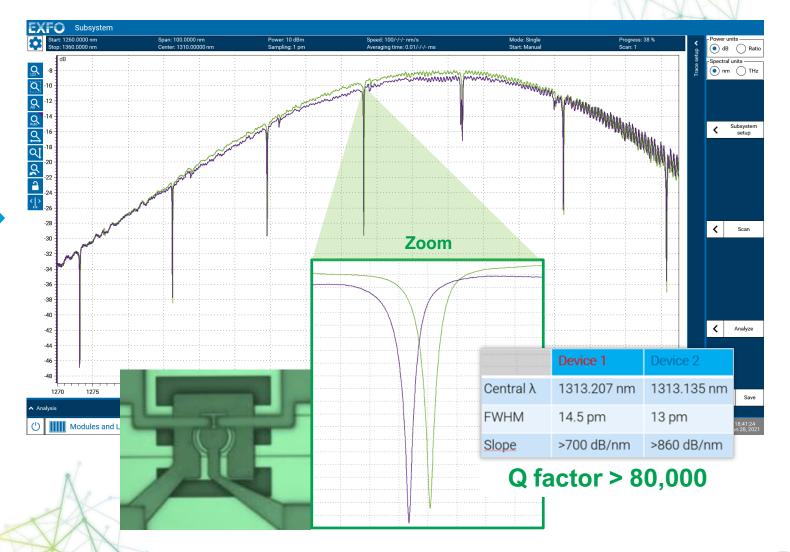




Future Proof

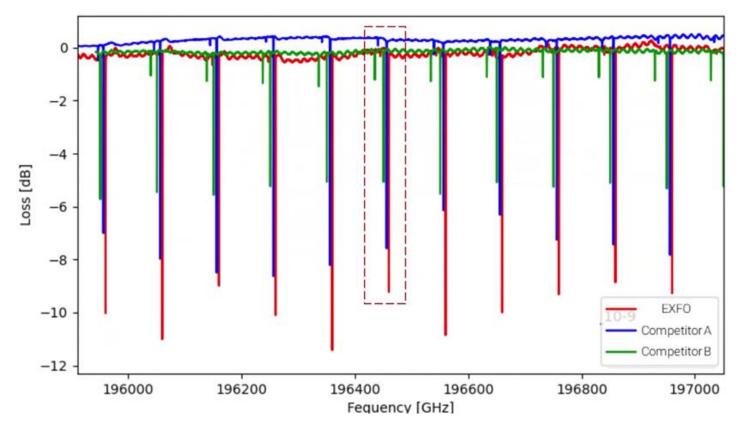
Slope measurement up to 10,000 dB/nm at 100 nm/s

Future-proof measurements for high-Q ring resonators.



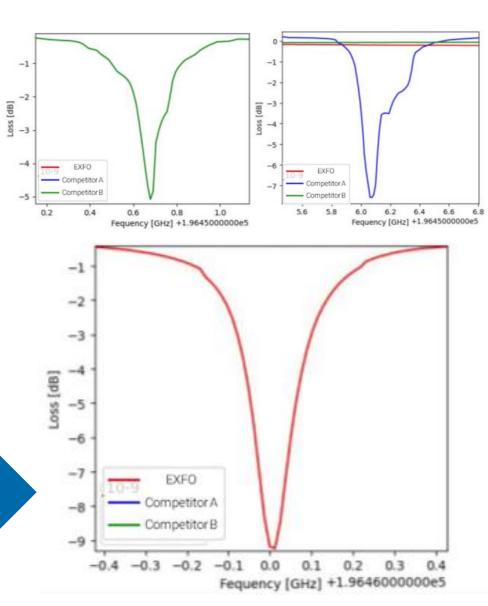
Latest innovation: Sub-picometer tracking







Sub-picometer resolution down to 20fm



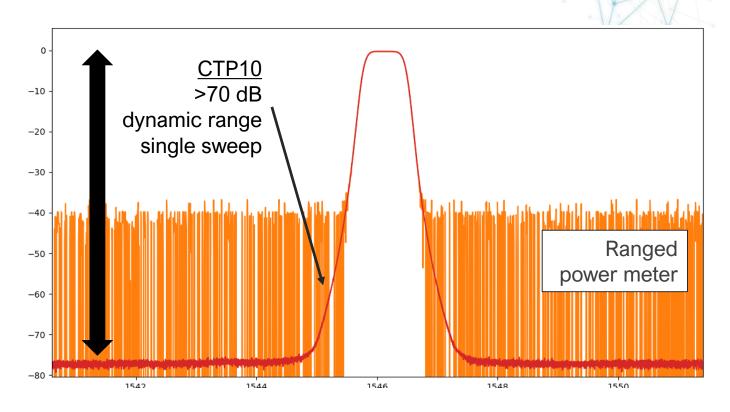
如何提升动态范围



2 to 3x speed increase

Range-free optical detectors

Single sweep measurement with >70 dB dynamic range ensures faster and more accurate measurements.



- 2 to 3 times speed improvement
- Single sweep, independent of system's repeatability
- No post-processing (trace stitching)

Latest innovation – PCMx module





Photocurrent testing

T500S – Continuously Tunable Lasers





CTP10 – Component Testing Platform

Optical



Photocurrent

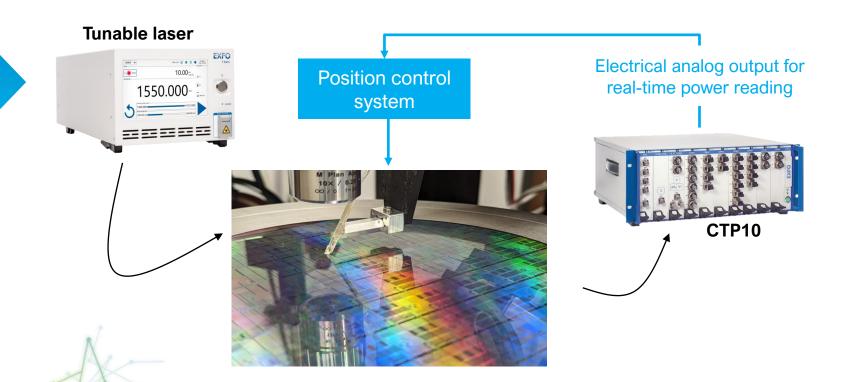
Photocurrent Meter Modules

Versatile optical testing

Multi-channel, from few to 100+ detectors with two CTP10 Multi-laser measurements with additional module

Analog output on powermeters, ideal for PIC alignment

PIC测试需求: 速度与精度



Flexible configuration on single-die station



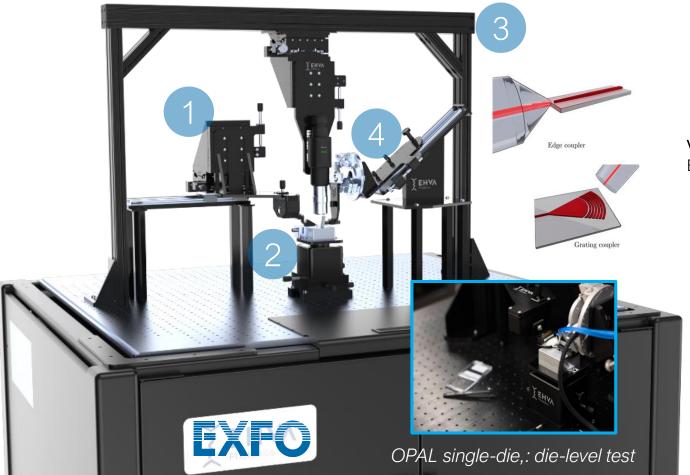
Semi-automated modular subsystems, fully compatible with wafer test stations



Electrical head: Manual 4D translation stage DC and RF probing



Single-die base stage: Manual 4D translation stage Vacuum (and thermal) chuck





Vision system: Bridge and 3D translation stage



Optical head:
6D motion system and rail system
Surface and edge coupling

Covering single-die testing





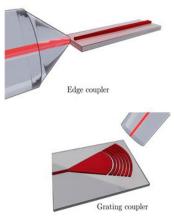
Versatile configuration for E/O alignement

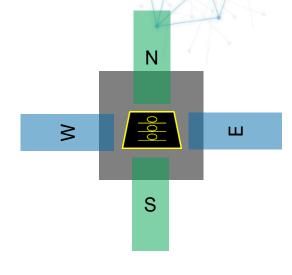
Choice of various probe handlers suitable for surface or edge coupling

Easy station configuration depending on E/O requirements

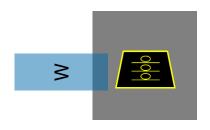
Thermal chuck as option

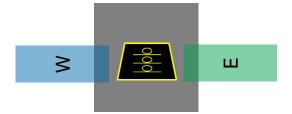












Easy to configure





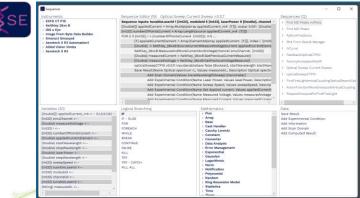
Single software for preparation, test and analysis

Automated flow from CAD file reading, chip parameter& test definitions, execution (movement, testing) and data analysis

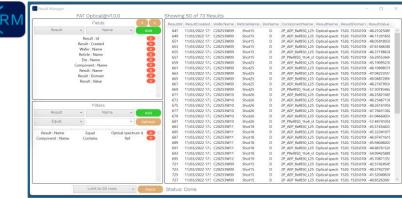
Database management accessible to multiple collaborators

Easily save, find, sort and analyze results through machine learning



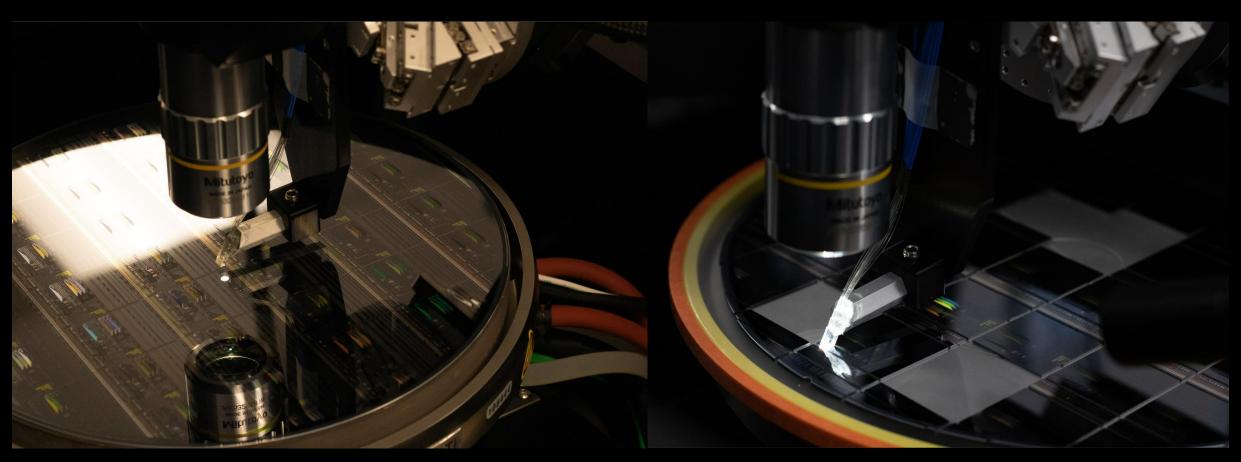






Powerful capabilities, readily available

Stretch-tape and multi-die



Save many steps!

Trench coupling capability



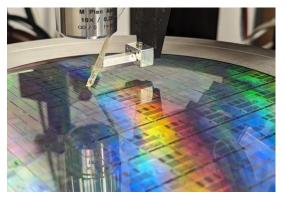




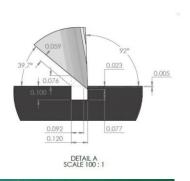
From die to automatic wafer-level testing without compromising performance

Test directly onto the wafer, even with trench coupling instrumentation

High accuracy and repeatability key to assure no collisions during wafer test









R&D grade instruments, ready for integrated photonics volume production

Probe station OPAL OPAL Edge OPAL Single Die Wafer coupling Swept tunable lasers Optical test Optical spectrum BER tester platform analyzer Light sources, VOA, opt. 1550.000switch, OSA, power meters **BA-4000** LAB-ON-A-RACK - PASSIVE + ACTIVE T200S T500S PASSIVE COMPONENT - ACTIVE COMPONENT Sampling scope **LTB-12** Passive optical **OSA20** component testers EA-4000 *FRAFFIC ANALYSIS* Tunable filters **OSICS** Clock recovery XTM-50 SPECTRAL SPECTRAL Matrix switch CTP10 CT440 **XTA-50** CD-4000 MXS-9100

PILOT – Full automation software

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